

PRF Series

PTC Thermistor PRF Series



Features

- Faster response
- Wide Sensing Temperature
- Compact Design to save Board space
- Low profile
- High Reliability
- RoHS Compliant and Halogen Free
- Safety Standard
(UL : E137188 VDE, TUV etc.)

Applications

- Automotive
(LED Lamp/Navigation/Motor/Electrical Component)
- LED Bulb
- Mobile phone
- Note PC, Tablet PC
- Battery
- Power Supply
- Motor and Motor Controller

Overview

Exploiting the PTC characteristic (a sharp increase in resistance above a certain temperature), the PRF series chip PTC thermistors are used for overheat sensing in FETs, power ICs, and other heat generating areas. Use of the sharp change in electrical resistance translates into outstanding noise resistance. Sharp changes in resistance make it possible to accurately detect overheating in multiple areas using a very simple circuit connecting PTC thermistors in series.

This allows the customer to reduce the number of IC ports, thereby downsizing equipment.

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Attention:

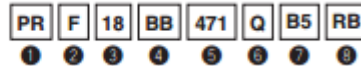
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2. Selection Guide

2.1 Part Numbering

PTC Thermistors (POSISTOR®) for Overheat Sensing Chip Type

(Part Number)



1. Product ID

Product ID	
PR	PTC Thermistors Chip Type

2. Series

Code	Series
F	for Overheat Sensing

3. Dimensions

Code	Dimensions
15	1.00 × 0.50mm
18	1.60 × 0.80mm
21	2.00 × 1.25mm

4. Temperature Characteristics

Code	Temperature Characteristics
AS	Curie Point 130°C
AR	Curie Point 120°C
BA	Curie Point 110°C
BB	Curie Point 100°C
BC	Curie Point 90°C
BD	Curie Point 80°C
BE	Curie Point 70°C
BF	Curie Point 60°C
BG	Curie Point 50°C

5. Resistance

Expressed by three figures. The unit is (Ω).

The first and second figures are significant digits, and the third figure expresses the number of zeros which follow the two figures.

Ex.)

Code	Resistance
471	470 Ω
102	1k Ω
103	10k Ω

6. Resistance Tolerance

Code	Sensing Temp. Tolerance
Q	+/-5 °C
R	+/-3 °C

7. Individual Specifications

Ex.)

Code	Individual Specifications
B5, B6, B7	Structure, others

8. Packaging

Code	Packaging
RA	Plastic Taping 4mm Pitch (4000pcs.)
RB	Paper Taping 4mm Pitch (4000pcs.)
RC	Paper Taping 2mm Pitch (10000pcs.)

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3. Specifications

3.1 Line up

			*at 4.7kohm	*at 47kohm		
Size [mm/in.]	Part Number	Resistance at 25°C [ohm]	Sensing Temperature(°C)	Sensing Temperature(2) (°C)	Max. Voltage [VDC]	Operation Temp. [°C]
2012/0805	PRF21AS471QB5RA	470+/-50%	145+/-5	-	32V	-20~+ 160
	PRF21AR471QB5RA	470+/-50%	135+/-5	-	32V	-20~+ 150
	PRF21BA471QB5RA	470+/-50%	125+/-5	-	32V	-20~+ 140
	PRF21BB471QB5RA	470+/-50%	115+/-5	-	32V	-20~+ 130
	PRF21BC471QB5RA	470+/-50%	105+/-5	-	32V	-20~+ 120
	PRF21BD471QB5RA	470+/-50%	95+/-5	-	32V	-20~+ 110
	PRF21BE471QB5RA	470+/-50%	85+/-5	-	32V	-20~+ 100
1608/0603	PRF18AS471QB5RB	470+/-50%	145+/-5	-	32V	-20~+ 160
	PRF18AR471QB5RB	470+/-50%	135+/-5	150+/-7	32V	-20~+ 160
	PRF18BA471QB5RB	470+/-50%	125+/-5	140+/-7	32V	-20~+ 150
	PRF18BB471QB5RB	470+/-50%	115+/-5	130+/-7	32V	-20~+ 140
	PRF18BC471QB5RB	470+/-50%	105+/-5	120+/-7	32V	-20~+ 130
	PRF18BD471QB5RB	470+/-50%	95+/-5	110+/-7	32V	-20~+ 120
	PRF18BE471QB5RB	470+/-50%	85+/-5	100+/-7	32V	-20~+ 110
	PRF18BF471QB5RB	470+/-50%	75+/-5	90+/-7	32V	-20~+ 100
	PRF18BG471QB5RB	470+/-50%	65+/-5	80+/-7	32V	-20~+ 90
	PRF18BB471RB5RB	470+/-50%	115+/-3	130+/-7	32V	-20~+ 140
	PRF18BC471RB5RB	470+/-50%	105+/-3	120+/-7	32V	-20~+ 130
	PRF18BD471RB5RB	470+/-50%	95+/-3	110+/-7	32V	-20~+ 120
	PRF18BE471RB5RB	470+/-50%	85+/-3	100+/-7	32V	-20~+ 110
	PRF18BF471RB5RB	470+/-50%	75+/-3	90+/-7	32V	-20~+ 100
	PRF18BG471RB5RB	470+/-50%	65+/-3	80+/-7	32V	-20~+ 90
	PRF18BC471MB7RB	470+/-20%	105+/-3	-	32V	-20~+ 130
	PRF18BD471MB7RB	470+/-20%	95+/-3	-	32V	-20~+ 120
	PRF18BE471MB7RB	470+/-20%	85+/-3	-	32V	-20~+ 110

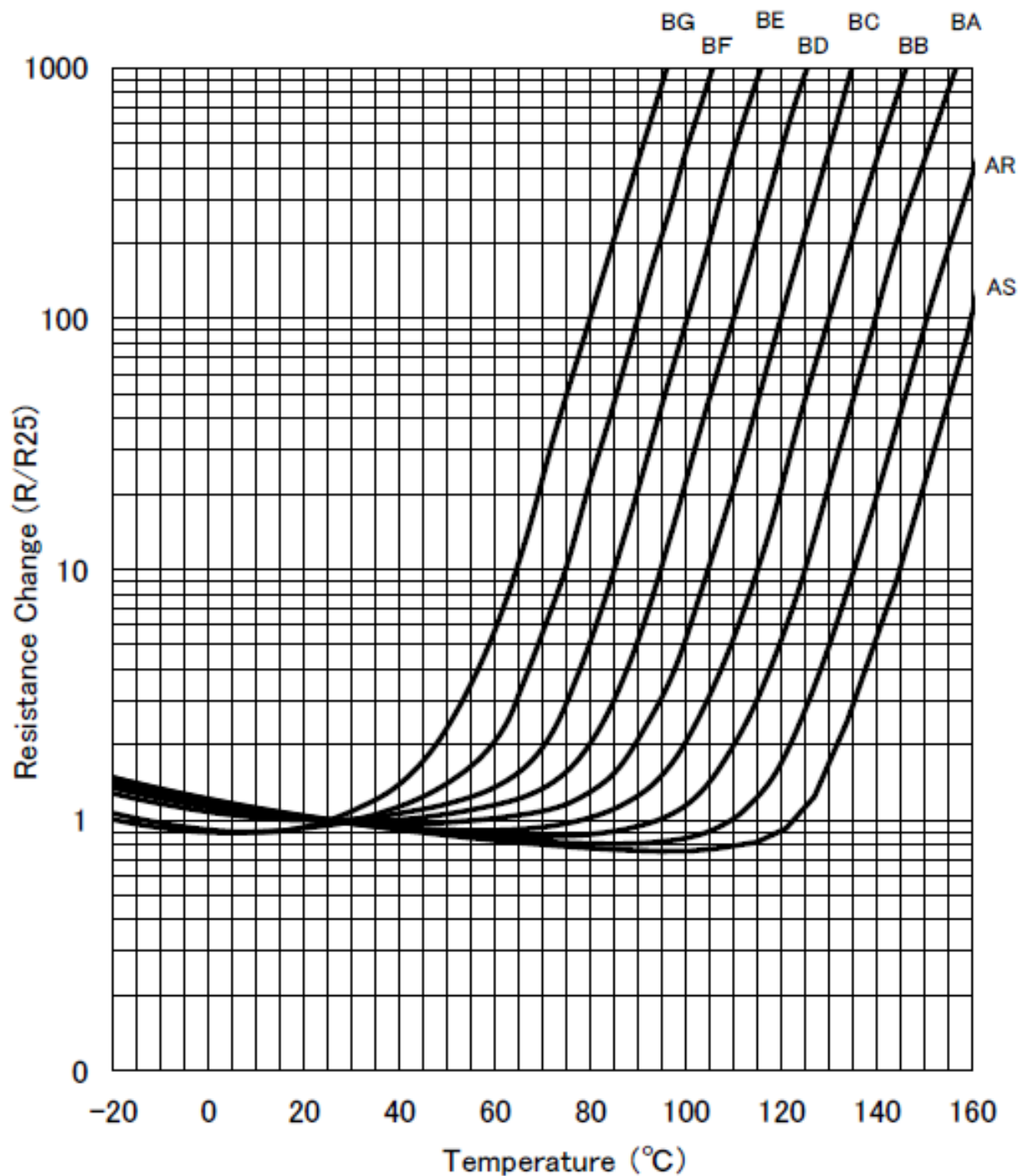
			*at 10kohm	*at 100kohm		
Size [mm/in.]	Part Number	Resistance at 25°C [ohm]	Sensing Temperature(°C)	Sensing Temperature(2) (°C)	Max. Voltage [VDC]	Operation Temp. [°C]
1005/0402	PRF15AR102RB6RC	1k+/-50%	135+/-5	150+/-3	32V	-40~+ 160
	PRF15BA102RB6RC	1k+/-50%	125+/-5	140+/-3	32V	-40~+150
	PRF15BB102RB6RC	1k+/-50%	115+/-5	130+/-3	32V	-40~+140
	PRF15BC102RB6RC	1k+/-50%	105+/-5	120+/-3	32V	-40~+130
	PRF15BD102RB6RC	1k+/-50%	95+/-5	110+/-3	32V	-40~+120
	PRF15BE102RB6RC	1k+/-50%	85+/-5	100+/-3	32V	-40~+110
	PRF15BF102RB6RC	1k+/-50%	75+/-5	90+/-3	32V	-40~+100
	PRF15BG102RB6RC	1k+/-50%	65+/-5	80+/-3	32V	-40~+90

			*at 100kohm	*at 4.7Mohm		
Size [mm/in.]	Part Number	Resistance at 25°C [ohm]	Sensing Temperature(°C)	Sensing Temperature(2) (°C)	Max. Voltage [VDC]	Operation Temp. [°C]
1005/0402	PRF15BB103RB6RC	10k+/-50%	> 110	130+/-3	32V	-20~+140
	PRF15BE103RB6RC	10k+/-50%	-	100+/-3	32V	-20~+110
	PRF15BG103RB6RC	10k+/-50%	-	80+/-3	32V	-20~+90

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3.2 Resistance-Temperature Characteristics Typical Curve



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3.3 Electrical characteristics

	Item	Specification	Test Condition
3.3.1	Resistance value at 25°C	Within the specified range	After applying maximum operating voltage for 3 mins. and leaving for 2 hours in 25°C, measured by applying voltage less than DC1.0V.
3.3.2	Temperature characteristics	The resistance change with temperature typical curve shown in Graph-1.	Resistance at each ambient temperature is Measured by the measurement current of 1mA or less.

3.4 Mechanical characteristics

	Item	Specification	Test Condition
3.4.1	Vibration	- Resistance (R25) change: Less than +/-20% (#) - Appearance: No defects or abnormalities	Reference standard: IEC 60068-2-6 (1995) - Soldered PTC to PCB (##) - Frequency range: 10~55Hz - Amplitude: 1.5mm - Sweep rate: 1octave/min. - Direction: X-Y-Z (3 direction) 24 cycles in each axis
3.4.2	Solderability	Wetting of soldering area: ≥95%	Reference standard: IEC 60068-2-58 (2004) - Solder: Sn-3.0Ag-0.5Cu - Solder temp.: 245+/-5°C - Immersion time: 3+/-0.3s
3.4.3	Resistance to soldering heat	- Resistance (R25) change: Less than +/-20% (#) - Appearance: No defects or abnormalities	Reference standard: IEC 60068-2-58 (2004) [Solder bath method] - Solder: Sn-3.0Ag-0.5Cu - Preheat: 150+/-5°C, 90~120s - Solder temp.: 260+/-5°C - Immersion time: 10+/-1s

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3.5 Environmental characteristics

	Item	Specification	Test Condition									
3.5.1	Dry Heat	• Resistance (R25) change: Less than +/-20% (#) • Appearance: No defects or abnormalities	Reference standard: IEC 60068-2-2 (2007) • Soldered PTC to PCB (##) • (Max. operating temp.)+/-2°C • 1000+48/-0 hrs.									
3.5.2	Cold		Reference standard: IEC 60068-2-1 (2007) • Soldered PTC to PCB (##) • (Min. operating temp.)+/-3°C • 1000+48/-0 hrs									
3.5.3	Damp heat		Reference standard: IEC 60068-2-67 (1995) • Soldered PTC to PCB (##) • +85+/-2°C, 85+/-5%RH • 1000+48/-0 hrs									
3.5.4	Thermal shock		Reference standard: IEC 60068-2-14 (2009) [Test Na] • Soldered PTC to PCB (##) • Transport time: ≤3 min. • Test condition: See below table <table><tr><th>Step</th><th>Condition</th><th>Time</th></tr><tr><td>1</td><td>(Min. operating temp.)+/-3°C</td><td>30min.</td></tr><tr><td>2</td><td>(Max. operating temp.)+/-2°C</td><td>30min.</td></tr></table> • Test cycle: 5cycles	Step	Condition	Time	1	(Min. operating temp.)+/-3°C	30min.	2	(Max. operating temp.)+/-2°C	30min.
Step	Condition		Time									
1	(Min. operating temp.)+/-3°C	30min.										
2	(Max. operating temp.)+/-2°C	30min.										
3.5.5	High temperature load	Reference standard: IEC 60068-2-2 (2007) • Soldered PTC to PCB (##) • (Max. operating temp.)+/-2°C • Applied max. voltage • 1000+48/-0 hrs.										

The resistance value after the test,

It is measured by applying voltage less than DC1.0V after left at 25±2°C for 2hrs.

Above mentioned soldering is done following condition at our side.

- Glass-Epoxy PC board
- Standard land dimension
- Standard solder paste
- Standard solder profile

Above conditions are mentioned in Notice.

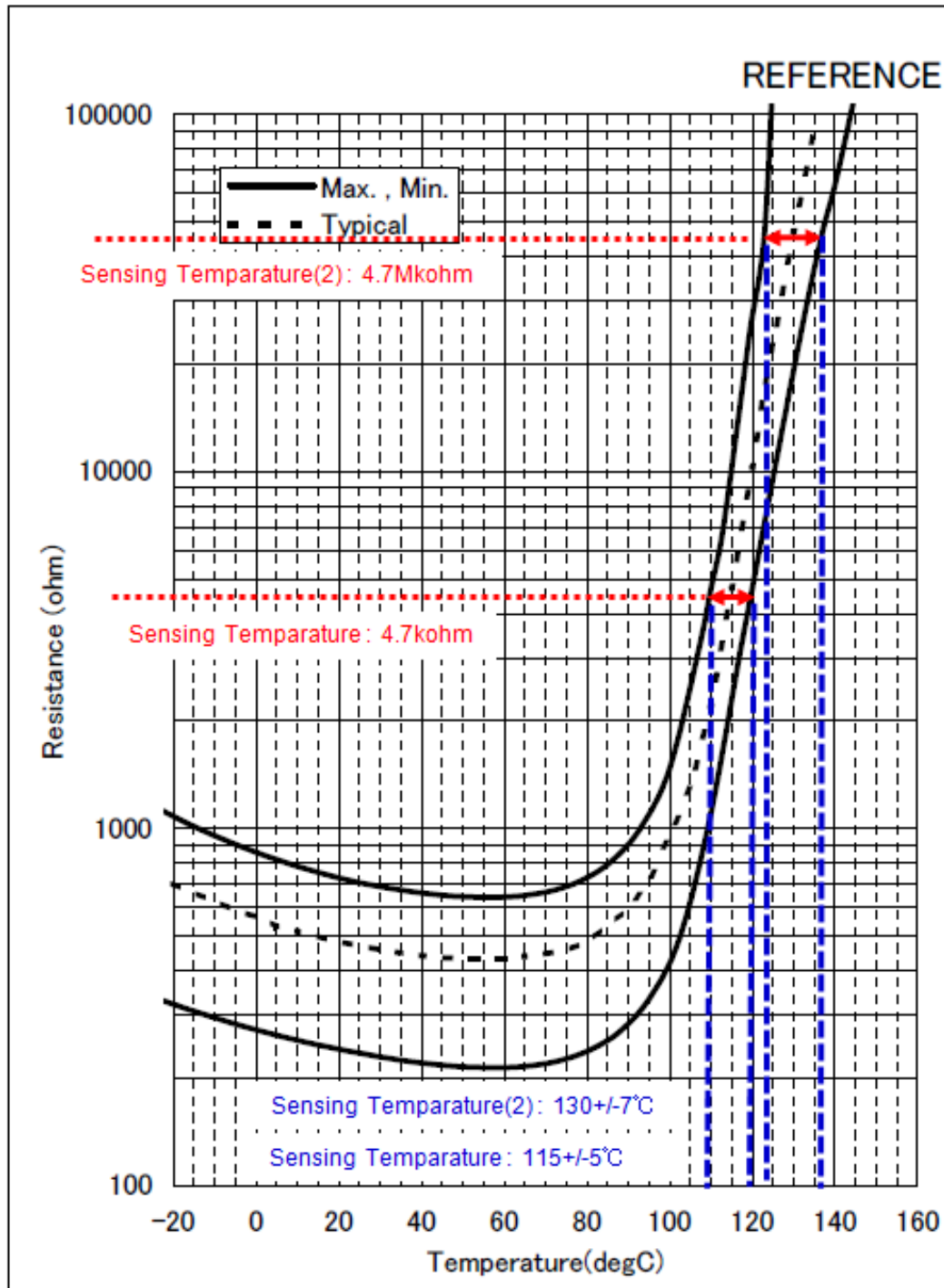
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4. Measurement direction

4.1 Resistance - Temperature characteristics Range (Reference)

Example PRF18 Series / BB Type

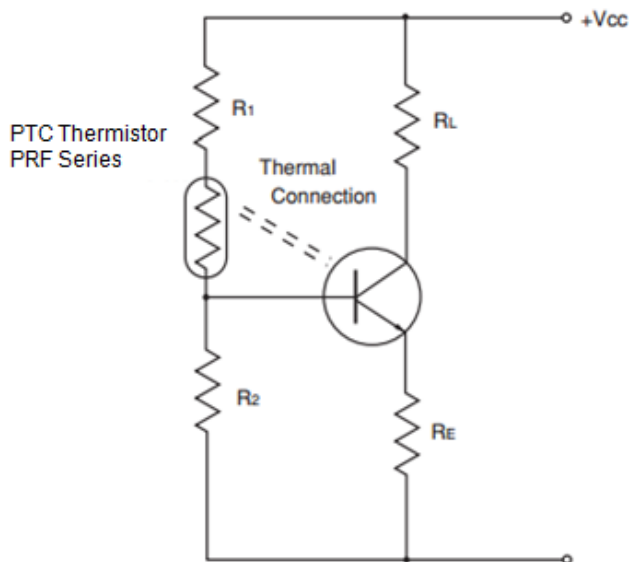


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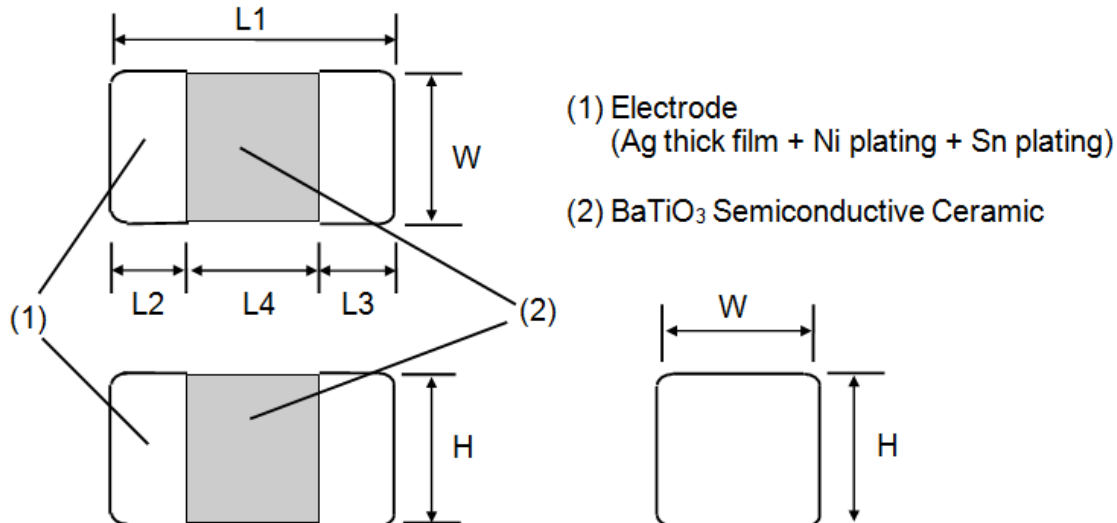
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4.2 Circuit (Reference)

Example



5. Dimension, Land Pattern



Size[mm/in.]	L1	W	H	L2 and L3	L4 (Min.)
1005/0402	1.00±0.05	0.50±0.05	0.50±0.05	0.15~0.35	0.3
1608/0603	1.60±0.15	0.80±0.15	0.80±0.15	0.10 ~ 0.60	—
2012/0805	2.00±0.20	1.25±0.20	0.90±0.20	Min. 0.20	Min. 0.50

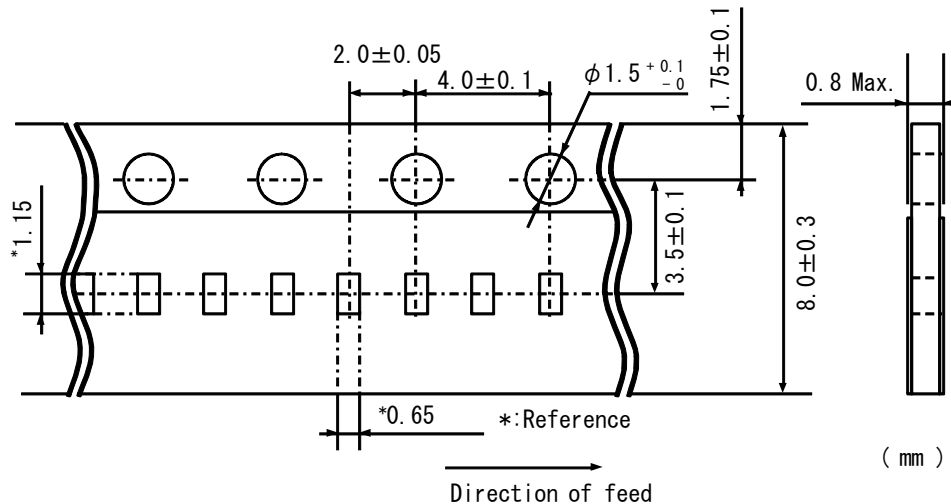
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6. Packing

6.1 Taping Specification

6.1.1 Dimensions of plastic tape (*Typical data of PRF18_RB Series)



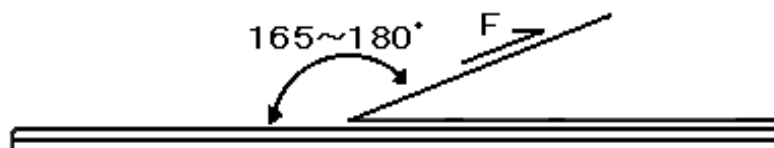
- (1) Products shall be packaged in the cavity of the base tape and sealed by top tape and bottom tape.
- (2) Top tape and bottom tape have no joints and products shall be packaged and sealed in the cavity of the base tape, continuously.

6.1.2 Tape strength

- (1) Pull strength of top tape and bottom tape shall be specified as follows:

Size[mm/in.]	Plastic tape	Cover tape
1005/0603	5N minimum	5N minimum
1608/0402		
2012/0805	5N minimum	10N minimum

- (2) Peeling force of top tape



- *1 peeling angle : 165 to 180 degree against the fixed surface of tape.
- *2 peeling speed : 300mm/min.
- *3 Peeling force : 0.1 ~ 0.6 N

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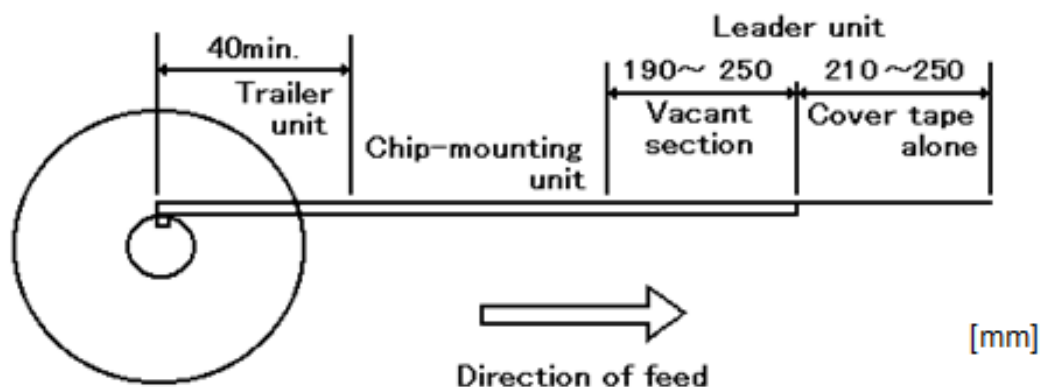
6.2 Reeling

6.1.1 Quantity (Standard Quantity)

Part Number	Products quantity in a reel
PRF15_RC	10,000 pcs. /reel
PRF18_RB	4,000 pcs. /reel
PRF21_RA	4,000 pcs. /reel

(2) A tape in a reel contains Leader unit and Trailer unit where products are not packed.

(See the following figure.)



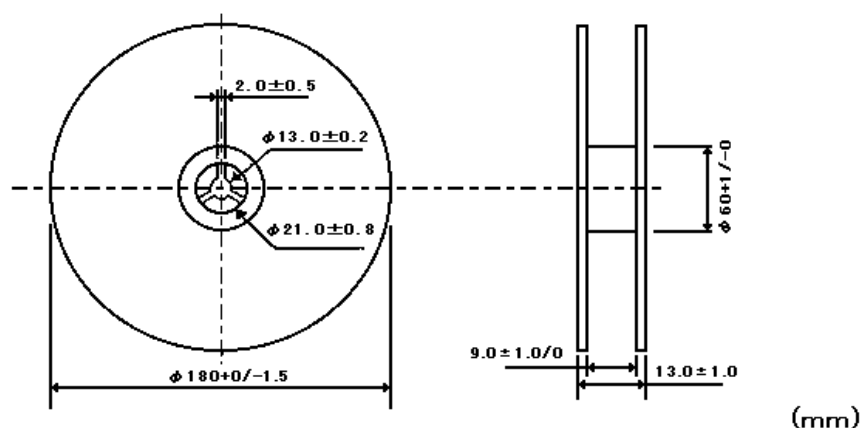
* The reeling specification above shall not be applied for the order less than Standard Quantity.

(3) The plastic tape and cover tape are not attached at the end of the tape (Vacant section) for a minimum of 5 pitches.

(4) A label shall be attached on the reel.

(MURATA's part number, inspection number and quantity shall be marked on the label.)

(5) Dimensions of reel.



6.1.2 Packing

The reeling shall be packed in a package. The label shall be attached on the package.

(Customer's name, order number, customer's part number, MURATA's part number and quantity shall be marked on a label.)

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7. Caution



1. This product is designed for application, which is used under ordinary environment. (room temperature, normal humidity, normal pressure) Do not expose this to the following environments, because all these factors can deteriorate the characteristic of this and can cause failure or burn out.
 - (1) Corrosive gas or deoxidizing gases (Cl₂, H₂S, NH₃, SO_x, NO_x etc.)
 - (2) Volatile, flammable gas
 - (3) Dusty place
 - (4) Place in a vacuum, reducing or putting pressure
 - (5) Place in splashed water, or high humidity and dewing place
 - (6) Salt water, oil, chemical liquid and solvent
 - (7) Vibratile place
 - (8) Other place equivalent to the above
2. Limitation of Applications
Please contact us before using our products for the under-mentioned applications requiring especially high reliability in order to prevent defects which might directly cause damage to other party's life body or property (listed below).
 - (1) Aircraft equipment (2) Aerospace equipment (3) Undersea equipment
 - (4) Power plant control equipment (5) Medical equipment
 - (6) Transportation equipment (automobiles, trains, ships, etc.) (7) Traffic signal equipment
 - (8) Disaster prevention / Crime prevention equipment (9) Data-processing equipment
 - (10) Applications of similar complexity or with reliability requirements comparable to the applications listed in the above
3. Be sure to provide an appropriate fail-safe function on your product to prevent a second damage that may be caused by the abnormal function or the failure of our product.

Notice

1. Do not apply abnormal voltage exceeding the specified maximum value.
Because they may deteriorate or destroy PTC element.
2. Use this product within the specified temperature. A higher temperature may deteriorate the characteristic or material.
3. The body of this product is not insulated. Please keep an adequate distance to surrounding components and wiring.

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4. Storage conditions

To keep solderability from declining, following storage condition is recommended.

- (1) Condition Temperature : -10 to +40°C
 Humidity : Less than 75%RH (not dewing condition)
- (2) Term: Please use this POSISTOR within 6 months after shipment by first-in and first-out stocking system.
- (3) Handling after seal open: After unpacking of the minimum package, reseal it promptly or store it inside a sealed container with a drying agent.
- (4) Place: Do not store this product in corrosive gas (SOx, Cl etc) or under sunlight.

5. Solder and Flux

(1) Solder Paste

Use Sn:Pb=60:40wt% , Sn:Pb=63:37wt% , Sn:Ag:Cu=96.5:3.0:0.5wt% or equivalent type of solder paste.

Do not use strong acidic flux (with halide content exceeding 0.2wt%).

Use of the solder containing Zn may reduce adhesive strength. When you use the solder containing Zn, please contact us in advance. For your reference, we are using
'63Sn/37Pb RMA9086 90-3-M18', manufactured by Alpha Metals Japan Ltd.,
'96.5Sn/3.0Ag/0.5Cu M705-GRN360-K2-V', manufactured by Senju Metal Industry Co., LTD.
for any Internal tests of this product.

(2) Flux

Use rosin type flux in soldering process.

If below flux is used, some problems might be caused in the product characteristics and reliability.

Please do not use below flux.

- Strong acidic flux (with halide content exceeding 0.2wt%).
- Water-soluble flux(*Water-soluble flux can be defined as non rosin type flux including wash-type flux and non-wash-type flux.)

6. For removing the flux after soldering, observe the following points in order to avoid deterioration of the characteristics or any change of the external electrodes quality.

(1) Cleaning Conditions

Solvent	Dipping Cleaning	Ultrasonic Cleaning
2-propanol	Less than 5 min. at room temp. or Less than 2 min. at 40°C max.	Less than 1 min. 20W/L max. Frequency of several 10 kHz to several 100 kHz.

A sufficient cleaning shall be applied to remove flux completely.

- (2) Drying: After cleaning, dry promptly this product.

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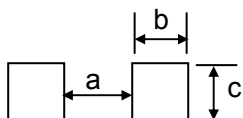
7. In your mounting process, observe the following points in order to avoid deterioration of the characteristics or destruction of this product. The mounting quality of this product may also be affected by the mounting conditions, shown the points below.

This product is for only reflow soldering. Flow soldering shall not be allowed.

Please mount this product by soldering. When mounted by other methods, such as conductive adhesives, please contact us in advance.

(1) Standard Land Size

Too big land size gives too much solder paste on the land. It may cause destruction of this product, because of the mechanical stress especially in the case of board bending.



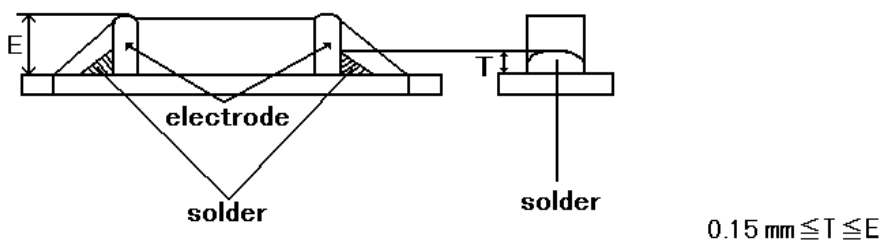
Soldering Methods	Size(mm/inch)	a	b	c
Flow Soldering	2012/0805	1.0~1.2	0.9~1.0	1.0~1.2
Reflow Soldering	2012/0805	1.0~1.2	0.5~0.7	1.0~1.2
Flow Soldering	1608/0603	0.6~1.0	0.8~0.9	0.6~0.8
Reflow Soldering	1608/0603	0.6~0.8	0.6~0.7	0.6~0.8
Reflow Soldering	1005/0402	0.5	0.4~0.5	0.5

(2) Printing Conditions of Solder Paste

i. Standard thickness of solder paste printing shall be from 0.10 to 0.15 mm.

ii. After soldering, the solder fillet shall be a height from 0.2 mm to the thickness of this product.

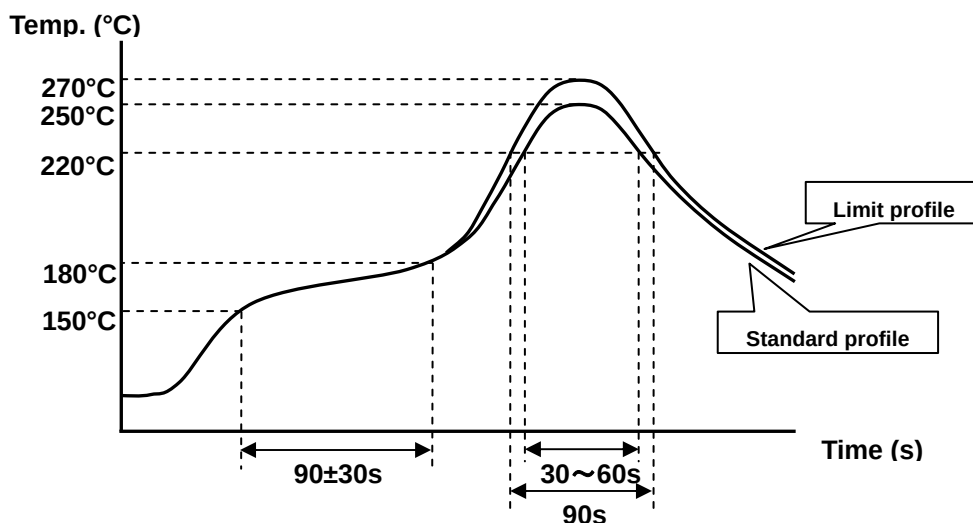
(See the figures below.)



iii. Too much solder gives too strong mechanical stress to this product, such stress may cause cracking or any mechanical damage. And also, it can destroy the electrical performance of this product.

(3) Reflow soldering conditions

The following figure and table show our recommended reflow profile.



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	Standard profile	Limit profile
Preheat	150~180°C, 90±30s	
Soldering time (≥220°C)	30~60s	90s
Soldering time	20s(245°C)	45s(250°C)
Peak temp.	250°C	270°C
Reflow cycle	Max. 2times	Max. 2times

I. Insufficient preheating may cause a crack on ceramic body.

The temperature difference between preheat and peak should be control within 100°C to prevent this.

II. The excessive soldering conditions may cause dissolution of metallization or deterioration of solder-wetting on the external electrode.

III. Rapid cooling by dipping in solvent or by other means is not recommended.

IV. Please evaluate it on your condition if you will do mounting using not applying condition to the above-mentioned.

(5) There is a fear of unexpected failures (tombstone, insufficient solder-wetting, etc.) in your mounting process, caused by the mounting conditions. Please evaluate if this product is correctly mounted under your mounting conditions.

(6) Conditions with Soldering Iron

When hand soldering by iron is applied, be sure to keep following conditions.

Item	Conditions
Preheating	at 150°C for 1 to 2 minute
Temperature of Iron-tip	350°C max.
Soldering Iron Wattage	30W max.
Diameter of Iron-tip	3mm dia. max.
Soldering Time	5sec. max.
Solder	H60A (Sn:Pb=60:40wt%) type , H63A (Sn:Pb=63:37wt%) type, Sn:Ag:Cu=96.5:3.0:0.5wt% or equivalent type.
Flux	Do not use strong acidic flux (with halide content exceeding 0.2wt%).
Caution	Do not allow the iron-tip to directly touch the ceramic body. Preheat the ceramic body and mounting board.

8. Do not give this product a strong press-force nor a mechanical shock. Because such mechanical forces

may cause cracking or chipping of this ceramic product.

9. Rapid cooling or heating during soldering is not recommended.

Such treatment may destroy the element.

10. Resin coating

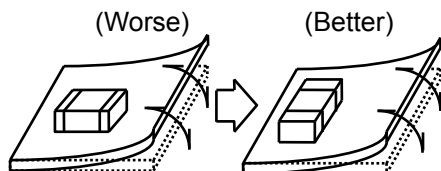
Please select the resin of which hardness shrinkage is much less, on selecting a resin materials.

Attention:

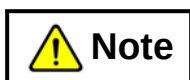
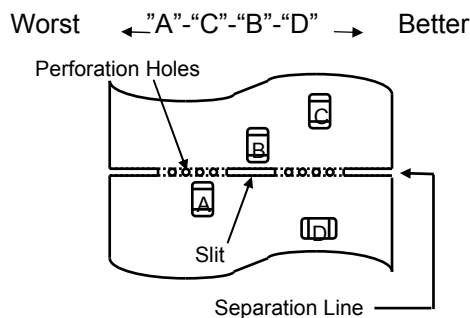
This datasheet is downloaded from the website of Murata Manufacturing Co., Ltd.
Therefore, it's specifications are subject to change or our products in it may be discontinued without advance notice.
Please check with our sales representatives or product engineers before ordering.

11. Location on Printed Circuit Board(PC Board)

<Component Direction>
Locate this product horizontal to the direction in which stress acts.



<Mounting Close to Board Separation Line>
Put this product on the PC Board near the Slit, not near the Perforation Holes.
Keep this product on the PC Board away from the Separation Line.



1. Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
2. You are requested not to use our product deviating from the agreed specifications.
3. We consider it not appropriate to include any terms and condition with regard to the business transaction in the product specification, drawings or other technical documents. Therefore, if your technical documents as above include such terms and conditions such as warranty clause, product liability clause, intellectual property infringement liability clause, or export control clause, they will be deemed to be invalid.

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